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October 13, 2000
Patrice Uchno Leland
Patrice L. Uchno Leland

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Serial No. 09/511,292
(Attorney Docket No. H-204325)

Filed February 23, 2000

James Nagashima
Terence G. Ward

Group 3743

APPARATUS AND METHOD FOR
MOUNTING A POWER MODULE

Examiner C. Atkinson

RECEIVED
OCT 23 2000
TC 3700 MAIL ROOM

AMENDMENT IN RESPONSE TO PAPER NO. 2

Commissioner for Patents
Washington DC 20231

In response to the Office Action mailed August 15, 2000, please amend the above-identified application as follows:

IN THE SPECIFICATION:

Page 3, line 10, after "manifold", insert - or heat sinking member -.

IN THE CLAIMS:

Amend Claims 1, 4 and 10 and add Claim 12 as follows:

1. (Amended) A cooling assembly comprising:

A1
a heat sinking member having a plurality of recesses defined therein, said heat sinking member receptive to coolant flow;